Product data sheet

1. General description

High-speed switching diode, encapsulated in a leadless ultra small DFN1006BD-2 (SOD882BD) Surface-Mounted Device (SMD) plastic package with side-wettable flanks.

2. Features and benefits

- High switching speed: t_{rr} ≤ 4 ns
- Low leakage current
- Repetitive peak reverse voltage V_{RRM} ≤ 100 V
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- Low capacitance
- Reverse voltage V_R ≤ 100 V
- · Ultra small and leadless SMD plastic package

3. Applications

- · High-speed switching
- · General-purpose switching

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------|-----------------------|-------------------------------------------------------|-----|-----|-----|-----|------|
| IF | forward current | T _j = 25 °C | [1] | - | - | 215 | mA |
| I _R | reverse current | V _R = 80 V; T _j = 25 °C | | - | - | 0.5 | μA |
| V _R | reverse voltage | T _j = 25 °C | | - | - | 100 | V |
| t _{rr} | reverse recovery time | I_F = 10 mA; I_R = 10 mA; R_L = 100 Ω; | | - | - | 4 | ns |
| | | I _{R(meas)} = 1 mA; T _{amb} = 25 °C | | | | | |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated and standard footprint.



High-speed switching diode

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|-------------------------|----------------|
| 1 | K | cathode | | K ├ A |
| 2 | Α | anode | | aaa-028035 |
| | | | Transparent top view | |
| | | | DFN1006BD-2 (SOD882BD) | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | | | | |
|-------------|---------|--------------------------------------------------------------------------------------------------------------------------------|----------|--|--|--|
| | Name | Description | Version | | | |
| BAS16LS | | Leadless ultra small plastic package with side-wettable flanks (SWF); 2 terminals; 0.65 mm pitch; 1 mm x 0.6 mm x 0.47 mm body | SOD882BD | | | |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| BAS16LS | м8 |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|---------------------------------|------------------------------------------------------------------|-----|-----|-----|------|
| V_{RRM} | repetitive peak reverse voltage | T _j = 25 °C | | - | 100 | V |
| V_R | reverse voltage | | | - | 100 | V |
| I _F | forward current | | [1] | - | 215 | mA |
| I _{FSM} | non-repetitive peak | t _p = 1 μs; square wave; T _{j(init)} = 25 °C | | - | 4 | Α |
| | forward current | t _p = 1 ms; square wave; T _{j(init)} = 25 °C | | - | 1 | А |
| | | t _p = 1 s; square wave; T _{j(init)} = 25 °C | | - | 0.5 | А |
| I _{FRM} | repetitive peak forward current | $t_p \le 0.5 \text{ ms}; \delta \le 0.25$ | | - | 500 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | [1] | - | 345 | mW |
| | | | [2] | - | 645 | mW |
| T _j | junction temperature | | | - | 150 | °C |
| T _{amb} | ambient temperature | | | -55 | 150 | °C |
| T _{stg} | storage temperature | | | -65 | 150 | °C |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated mounting pad for cathode 1cm².

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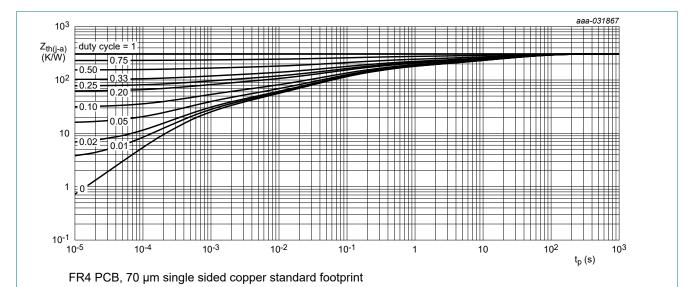
High-speed switching diode

9. Thermal characteristics

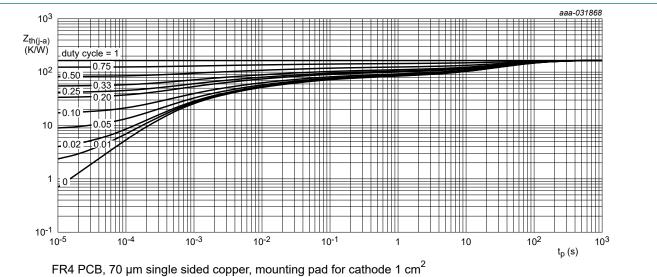
Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|---------|---------------------------------------------|------------|-----|-----|-----|-----|------|
| ui()-a) | thermal resistance from junction to ambient | | [1] | - | - | 360 | K/W |
| | | | [2] | - | - | 195 | K/W |

- Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated mounting pad for cathode 1cm².



Transient thermal impedance from junction to ambient as a function of pulse duration; typical values Fig. 1.



Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

Fig. 2.

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10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|-------------------------------|--------------------------------------------------------------------------------------|-----|-----|------|------|
| V _F | forward voltage | I_F = 1 mA; t_p ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C | - | - | 715 | mV |
| | | I_F = 10 mA; t_p ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C | - | - | 855 | mV |
| | | I_F = 50 mA; t_p ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C | - | - | 1 | V |
| | | I_F = 150 mA; $t_p \le 300$ μs; $δ \le 0.02$; T_{amb} = 25 °C | - | - | 1.25 | V |
| I _R | reverse current | V _R = 25 V; T _j = 25 °C | - | - | 30 | nA |
| | | V _R = 80 V; T _j = 25 °C | - | - | 0.5 | μΑ |
| | | V _R = 25 V; T _j = 150 °C | - | - | 30 | μΑ |
| | | V _R = 80 V; T _j = 150 °C | - | - | 50 | μΑ |
| C _d | diode capacitance | V _R = 0 V; f = 1 MHz; T _{amb} = 25 °C | - | - | 1.5 | pF |
| t _{rr} | reverse recovery time | I_F = 10 mA; I_R = 10 mA; R_L = 100 Ω; $I_{R(meas)}$ = 1 mA; T_{amb} = 25 °C | - | - | 4 | ns |
| V_{FRM} | peak forward recovery voltage | $I_F = 10 \text{ mA}; t_r = 20 \text{ ns}; T_{amb} = 25 \text{ °C}$ | - | - | 1.75 | V |

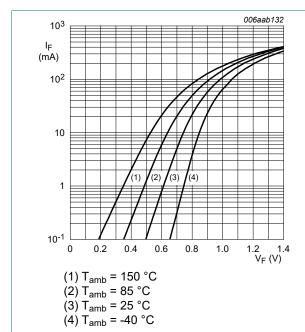
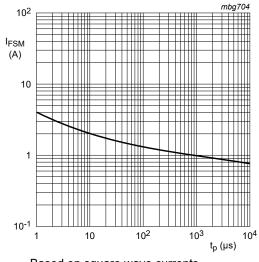


Fig. 3. Forward current as a function of forward voltage; typical values



Based on square wave currents. $T_{i(init)} = 25 \, ^{\circ}C$

Fig. 4. Non-repetitive peak forward current as a function of pulse duration; typical values

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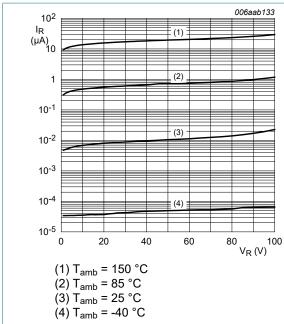
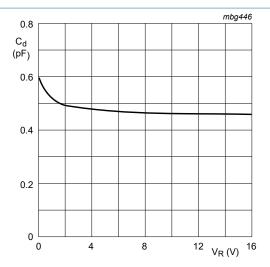


Fig. 5. Reverse current as a function of reverse voltage; typical values

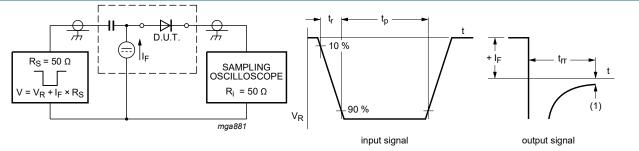


f = 1 MHz; T_{amb} = 25 °C

Diode capacitance as a function of reverse Fig. 6. voltage; typical values

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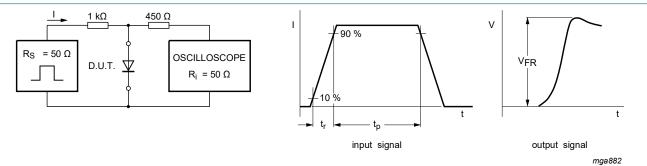
11. Test information



(1) $I_R = 1 \text{ mA}$

Input signal: reverse pulse rise time t_r = 0.6 ns; reverse voltage pulse duration t_p = 100 ns; duty cycle δ = 0.05 Oscilloscope: rise time t_r = 0.35 ns

Fig. 7. Reverse recovery time test circuit and waveforms

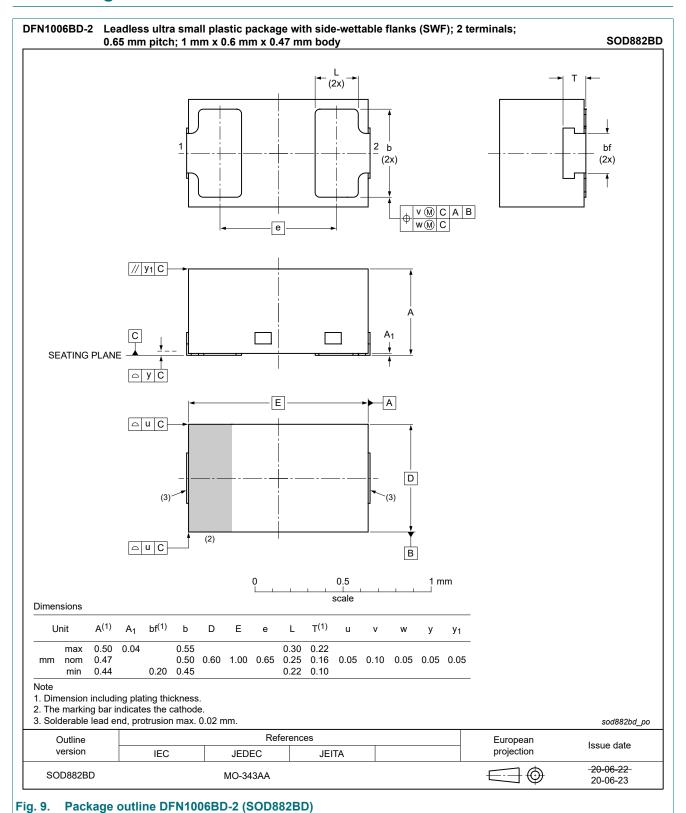


Input signal: forward pulse rise time t_r = 20 ns; forward current pulse duration $t_p \ge 100$ ns; duty cycle $\delta \le 0.005$

Fig. 8. Forward recovery voltage test circuit and waveforms

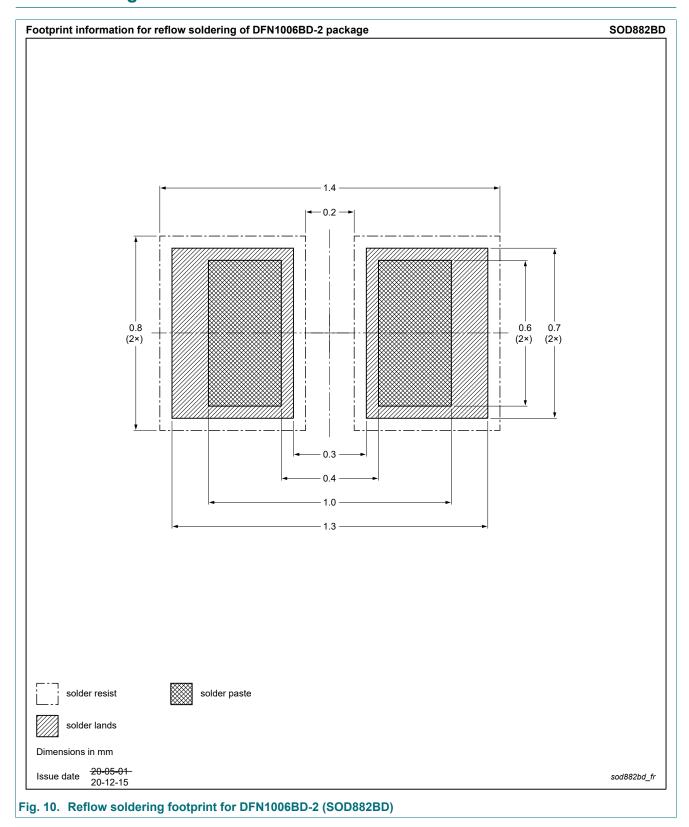
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12. Package outline



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13. Soldering



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14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes | | | | |
|---------------|-------------------|-------------------------------------------------------------------------------|---------------|-------------|--|--|--|--|
| BAS16LS v.2 | 20210209 | Product data sheet | - | BAS16LS v.1 | | | | |
| | Changed to non-au | Changed to non-automotive. Please refer to the automotive product(s) with -Q. | | | | | | |
| BAS16LS v.1 | 20200907 | Product data sheet | - | - | | | | |

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15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|-----------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- Please consult the most recently issued document before initiating or completing a design.
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